Declaration For U.S. Patent Appareation

As a below nam	ned inventor, I hereby declare that:			
My residence, p	ost office address and citizenship are as st	tated below next to my name.		
I believe I am the names are listed (Insert Title)	ne original, first and sole inventor (if only below) of the subject matter which is cla SEBUM-ADSORBENT POWDER A	one name is listed below) or imed and for which a patent i ND USE THEREOF	an original, first and joint invents sought on the invention entitle	or (if plural ed
the specification	n of which is attached hereto unless the fo	llowing is checked:		
	was filed on	filed onas United States Application Number or PCT Internat		PCT International
	Application Number		and was amended on	
<u>. ——</u>	(if applicable).			
I hereby state th by any amendm	nat I have reviewed and understand the conent referred to above.	ntents of the above-identified	specification, including the claim	n(s), as amended
I acknowledge t	he duty to disclose information which is ma	aterial to patentability as defin	ed in Title 37, Code of Federal R	egulations, § 1.56.
inventor's certif	oreign priority benefits under Title 35, Unicate listed below and have also identified that of the application on which priority is	l below any foreign applicatio	(d) of any foreign application(s) on for patent or inventor's certific	cate having a fil-
ID .n	2000-204587	Japan	06/07/2000	Priority Claimed X Yes No
(List propriet	(Number)	(Country)	(Day/Month/Year Filed)	Q Yes Q No
applications. See notelA on back∓of	(Number)	(Country)	(Day/Month/Year Filed)	Yes No
this page)	(Number)	(Country)	(Day/Month/Year Filed)	☐ Yes ☐ No
	(Number)	(Country)	(Day/Month/Year Filed)	
351	back of this page)	thed list for additional prior for ode, § 119(e) of any United S		isted below.
	(Application Numb	er)	(Filing Date)	
	(Application Numb	er)	(Filing Date)	
subject matter o the first paragra ity as defined in	he benefit under Title 35, United States C of each of the claims of this application is ph of Title 35, United States Code, § 112, Title 37, Code of Federal Regulations, § or PCT international filing date of the ap	not disclosed in the prior Uni I acknowledge the duty to di 1.56 which became available	ted States application in the mar sclose information which is mat	mer provided by erial to patentabil-
(List Prior U.S Applications)	S. (Application Serial Number)	(Filing Date)	(Status) (patented, pending, abandoned)	
	(Application Serial Number)	(Filing Date)	(Status) (patented, pending	ng, abandoned)
I hereby appoin	t the following attorney(s) and/or agent(s)	to prosecute this application	and to transact all business in th	e Patent and

Trademark Office connected therewith:

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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Full name of se	eventh inventor (given name, family name)	
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